

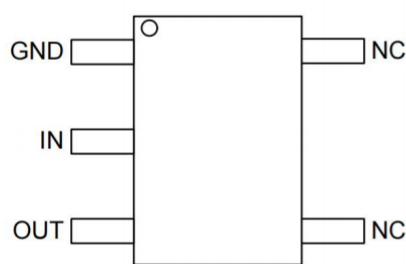
Features

- 2.5 μ A Current at no Load
- $\pm 2\%$ Output Accuracy
- 150mA Output Current
- Current Limit Protection

Applications

- Industrial Controls
- Home Automation
- Wireless power tools
- Motor driver and control board

PIN CONFIGURATION

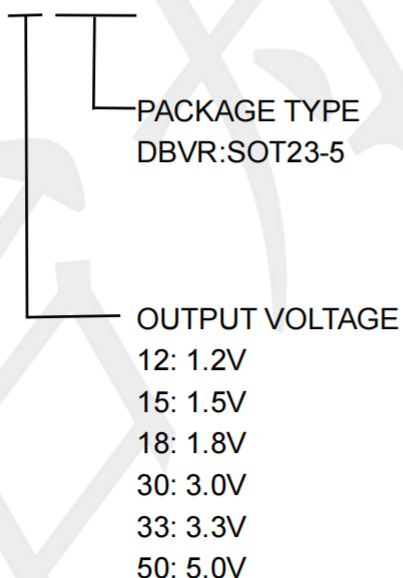


SOT23-5

Pin Number	Pin Name	Pin Function
1	GND	Ground
2	VIN	Input of Supply Voltage
3	VOUT	Output of the Regulator
4	NC	NO Connected
5	NC	NO Connected

Ordering Information

TLV704 XX DBVR



Example: TLV70436DBVR

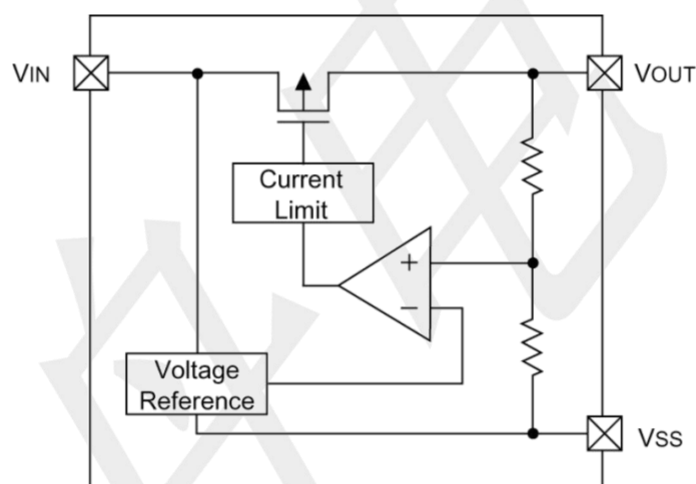
→ 3.6V Version, in SOT23-5 Package & Tape & Reel Packing Type

Absolute Maximum Ratings

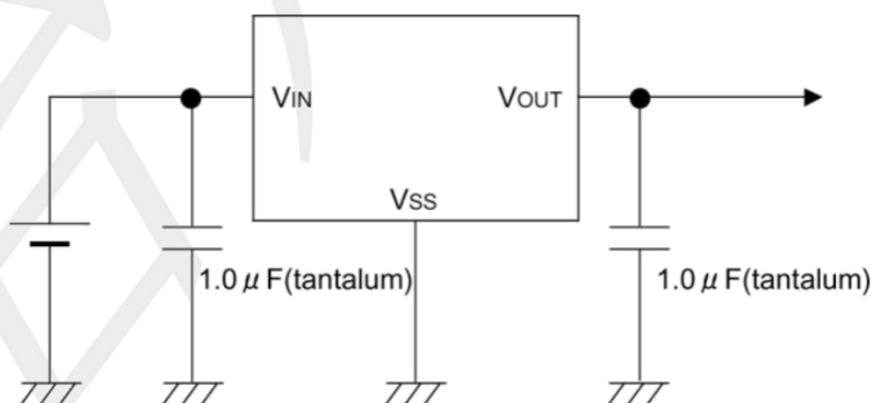
over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
VIN	Continuous input voltage range	-0.3	28	V
VOUT	Output voltage range	-0.3	5	
Current	Maximum output current	Internally limited		mA
Temperature	Operating Temperature, Topr	-40	85	°C
	Storage, Tstg	-55	125	
Power Dissipation	SOT23-5 Pd	300		mW
ESD	HBM mode, ESDA/JEDECJS-001-2017	2000		V

BLOCK DIAGRAM



Typical Application Circuit



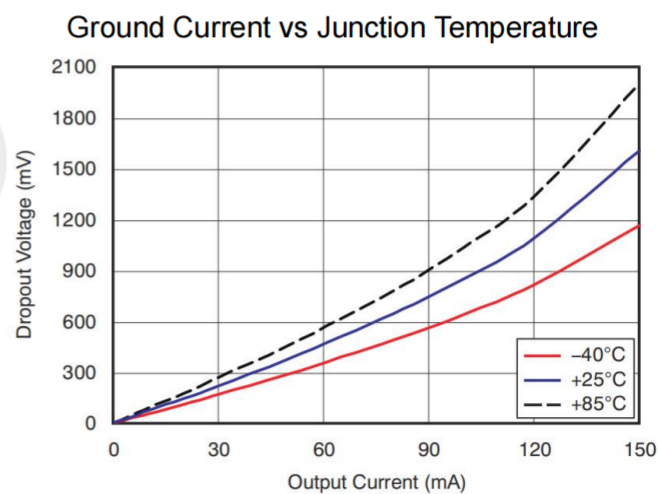
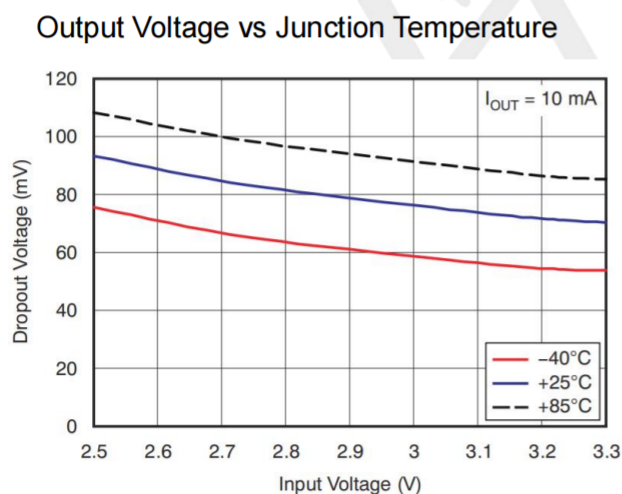
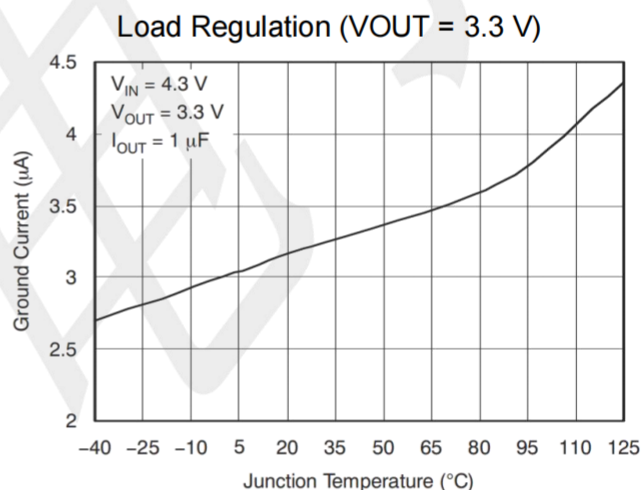
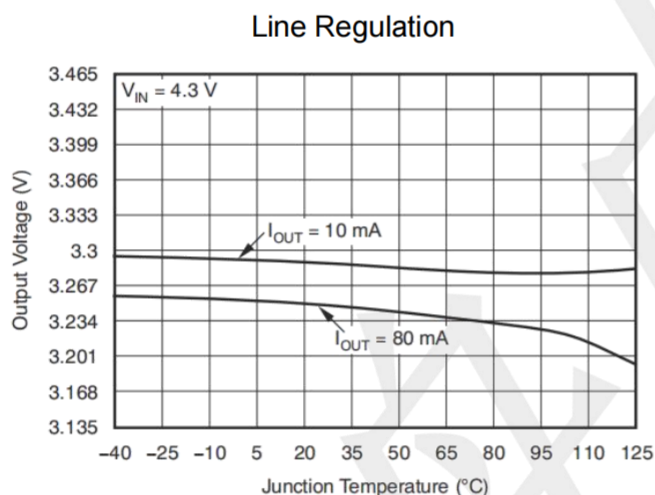
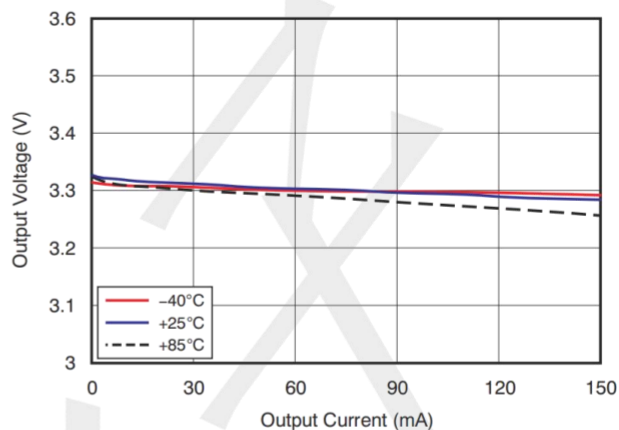
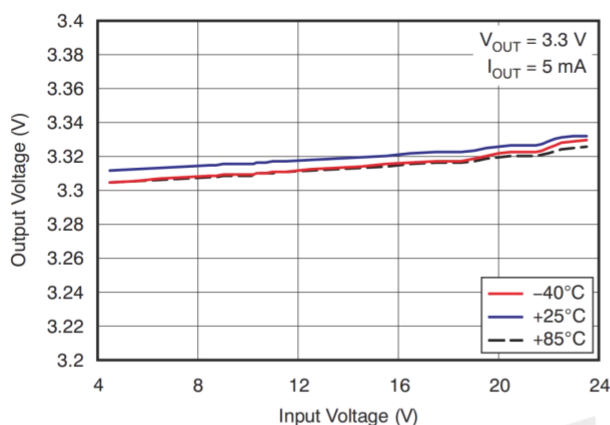
Electrical Characteristics

(TA=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST Conditions	MIN	TYP	MAX	UNIT
Supply Voltage	V _{IN}		2.2	--	24	V
Output current	I _{OUT}		0	150	200	mA
DC Output Voltage Accuracy		I _{OUT} = 0.1mA	-2	--	2	%
Dropout Voltage (V _{IN} -V _{OUT})	I _{OUT} = 100mA	V _{OUT} = 1.5V	--	400	--	mV
		V _{OUT} = 1.8V	--	380	--	
		V _{OUT} = 3.0V	--	350	--	
		V _{OUT} = 3.3V	--	330	--	
		V _{OUT} = 5.0V	--	300	--	
Ground Current (I _{OUT} = 0mA)	I _Q	V _{OUT} = 3.3V	--	1.5	2.5	uA
Shutdown Ground Current	I _{SD}	V _{EN} = 0V, V _{OUT} = 0V	--	0.01	0.5	
V _{OUT} Shutdown Leakage Current	I _{LEAK}		--	0.01	0.5	
Line Regulation	ΔLINE	I _{OUT} = 1mA, 10 ≤ V _{IN} ≤ 18V	--	0.3	--	%
Load Regulation	ΔLOAD	10mA ≤ I _{OUT} ≤ 100mA	--	0.3	--	
Output Current Limit	I _{LIM}	V _{OUT} = 0.9 × V _{OUT(NOM)}	250	300	--	mA
Power Supply Rejection Ratio	PSRR	V _{OUT} = 5V, I _{OUT} = 30mA, V _{IN} = 12V, f = 1kHz	--	70	--	dB
Thermal Shutdown Temperature	T _{SD}	I _{OUT} = 10mA	--	160	--	°C
Thermal Shutdown Hysteresis	ΔT _{SD}		--	15	--	
Package Thermal Resistance (Note 1)	SOT23-5 TJA	Thermal Resistance Junction-to-Ambient	--	200	--	°C/W

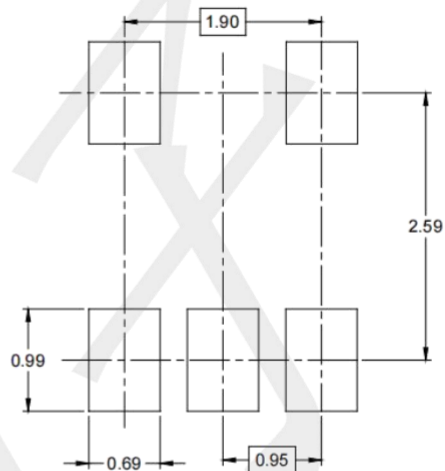
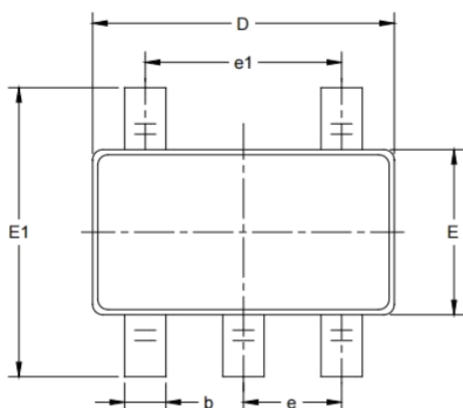
Note: 1. Test condition: the device is mounted on FR-4 substrate PC board, with minimum recommended pad layout.

Typical Operating Characteristics (25 °C, unless otherwise noted)

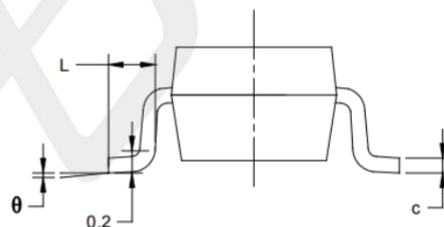
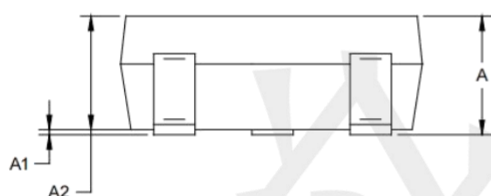


Package information

SOT23-5



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°